

03-22-2004

FORM COVER SHEET

Patents Only

To the Honorable Commission

March 16, 2004

Attorney Dkt: 5649-1159

Please record the attached original documents of copy 25

1. Name of conveying party(ies):

Gi-ho Park

3-16-04

2. Name and address of receiving party(ies):

Samsung Electronics Co., Ltd.  
416 Maetan-dong, Yeongtong-gu  
Suwon, Gyeonggi-do  
Republic of Korea

22856 U.S. PTO  
10/801893

031604

Additional name(s) of conveying party(ies) attached? Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment  
☐ Merger  
☐ Security Agreement  
☐ Change of Name  
☐ Other

Execution Date: February 18, 2004Additional name(s) & address(es) attached? Yes ☒ No

4. Application Serial No. \_\_\_\_\_; Filed: \_\_\_\_\_

10801893

If this document is being filed together with a new application, the execution date of the application  
is: February 18, 2004

Additional numbers attached? Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Robert N. Crouse  
Myers Bigel Sibley & Sajovec  
P.O. Box 37428  
Raleigh, North Carolina 27627

6. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41) \$ 40.00

☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit account number: 50-0220

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert N. Crouse, #44,635

Signature

Date

3/16/04

Total number of pages including cover sheet, attachments and document: 3

03/22/2004 MSETACHE 00000122 10801893

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PATENT  
REEL: 015101 FRAME: 0758

ASSIGNMENT

THIS ASSIGNMENT, made by me, **Gi-ho Park**; citizen of the Republic of Korea, residing at 116-1404, Hanjin Apt., Haengdang 2-dong, Seongdong-gu, Seoul, Republic of Korea ;

WITNESSETH: That,

WHEREAS, I am the sole inventor of certain new and useful improvements in **METHODS, CIRCUITS, AND SYSTEMS FOR UTILIZING IDLE TIME IN DYNAMIC FREQUENCY SCALING CACHE MEMORIES**, for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. I hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. \_\_\_\_\_, filed \_\_\_\_\_) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, **Samsung Electronics Co., Ltd.**, a Korean corporation having a principal place of business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

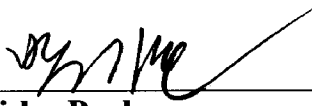
NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made.

I hereby request that said Letters Patent be issued in accordance with this assignment.

I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

I further covenant and agree to bind my heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to me relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 18 day of February, 2004.

  
\_\_\_\_\_  
**Gi-ho Park** (SEAL)

Witnessed by:

\_\_\_\_\_

Date: \_\_\_\_\_